

WIRE-BONDING probe and soldering station for microwave circuits



Sensor system



Description

Probe station adapted to take measurements in terahertz wavebands, featuring a structuring laser system

- JBC soldering station with different terminals
- Wire-bonding station
- Probe station for on wafer measurements
- Assembly and microwave circuit soldering bench

Uses and applications

Development of radio-frequency subsystems that operate in microwave, millimetre and terahertz wavebands.

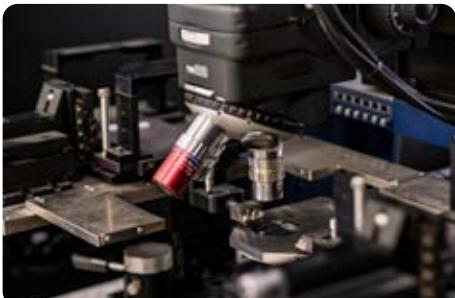
Equipment classification

Demo units.

Associated services

- Advice on wireless technologies for Industry 4.0.
- Seminar on cutting-edge technologies for connectivity.

Photos



Organisation



Universidad de
Oviedo

Web
www.tsc.uniovi.es

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Equipment code
N1.16

Service code
A.4
F.8

